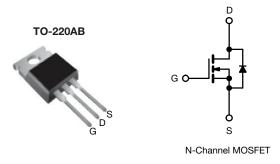
SiHP7N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.6		
Q _g max. (nC)	40			
Q _{gs} (nC)	5			
Q _{gd} (nC)	9			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION		
Package	TO-220AB	
Lead (Pb)-free	SiHP7N60E-E3	
Lead (Pb)-free and halogen-free	SiHP7N60E-BE3	
Lead (FD)-field and flatogen-field	SiHP7N60E-GE3	

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage		N/	600	
Drain-source voltage	$T_{C} = -25 \text{ °C}, I_{D} = 250 \mu\text{A}$	V _{DS}	575	V
Gate-source voltage	ate-source voltage		± 30	
	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		7	А
Continuous drain current ($T_J = 150 \ ^\circ C$)	V_{GS} at 10 V $T_C = 100 \text{ °C}$	I _D	5	
Pulsed drain current ^a	I _{DM}	18		
Linear derating factor			0.63	W/°C
Single pulse avalanche energy ^b		E _{AS}	43	mJ
Maximum power dissipation		PD	78	W
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C	-1) / / -14	70	
Reverse diode dV/dt ^d		dV/dt	3	V/ns
Soldering recommendations (peak temperature) ^c	For 10 s	1	300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 13.8 mH, R_g = 25 Ω , I_{AS} = 2.5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 62 - 1.6						
Maximum junction-to-case (drain)	R _{thJC}				°C/W			
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherw	ise noted)						
PARAMETER	SYMBOL	1		NS	MIN.	TYP.	MAX.	UNI
Static	0111202						in da	
Drain-source breakdown voltage	V _{DS}	Vec	= 0 V, I _D = 250) IIA	609	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$		e to 25 °C, I _D		-	0.68	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 250		2	-	4	V
	GS(III)		$V_{GS} = \pm 20 V$		-	_	± 100	nA
Gate-source leakage	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$ $V_{GS} = \pm 30 \text{ V}$		-	_	± 100	μΑ	
	$V_{\text{GS}} = \pm 30 \text{ V}$		- 0 V	-	_	1	μη	
Zero gate voltage drain current	I _{DSS}		$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		_	_	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	1	3.5 A	-	0.5	0.6	Ω
Forward transconductance	g _{fs}		= 50 V, I _D = 3		-	1.9	-	S
Dynamic	010		, ,		I		1	<u> </u>
Input capacitance	C _{iss}	$V_{GS} = 0 V, V_{DS} = 100 V, f = 1 MHz$		-	680	-	pF	
Output capacitance	C _{oss}			-	39	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	– V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	34	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	100	-		
Total gate charge	Qg	V _{GS} = 10 V I _D = 3.5 A, V _{DS} = 480 V		-	20	40	nC	
Gate-source charge	Q _{gs}			-	5	-		
Gate-drain charge	Q _{gd}				-	9	-	
Turn-on delay time	t _{d(on)}		•		-	13	26	
Rise time	t _r	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 3.5 \text{ A}, \\ V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	13	26	- ns	
Turn-off delay time	t _{d(off)}			-	24	48		
Fall time	t _f			-	14	28		
Gate input resistance	Rg	f = 1 MHz, open drain		-	1.1	-	Ω	
Drain-Source Body Diode Characterist	ics	•				•	•	•
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7		
Pulsed diode forward current	I _{SM}			-	-	18	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 3.5 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}				-	230	-	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 3.5 \text{ A},$ $dI/dt = 100 \text{ A}/\mu\text{s}, V_R = 20 \text{ V}$		-	1.9	-	μC	
Reverse recovery current	I _{RRM}			-	14	<u> </u>	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

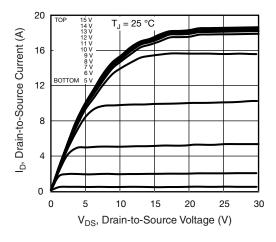


Fig. 1 - Typical Output Characteristics

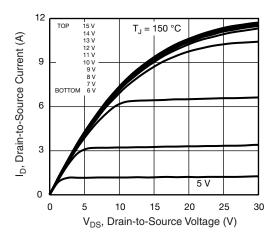


Fig. 2 - Typical Output Characteristics

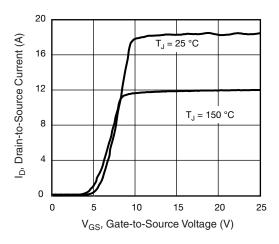


Fig. 3 - Typical Transfer Characteristics

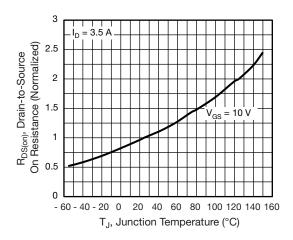


Fig. 4 - Normalized On-Resistance vs. Temperature

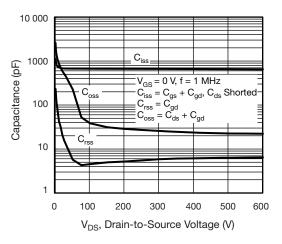


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

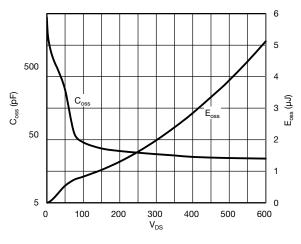


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

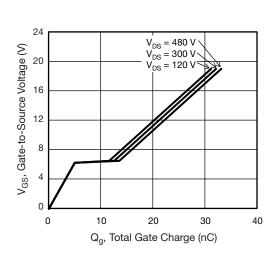
3

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Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

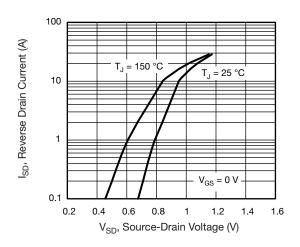


Fig. 8 - Typical Source-Drain Diode Forward Voltage

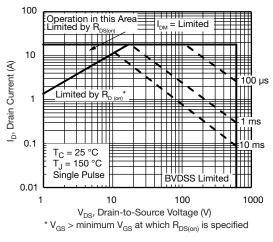


Fig. 9 - Maximum Safe Operating Area

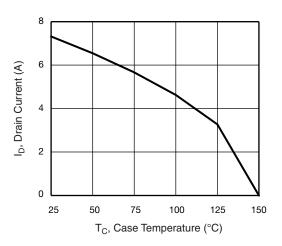


Fig. 10 - Maximum Drain Current vs. Case Temperature

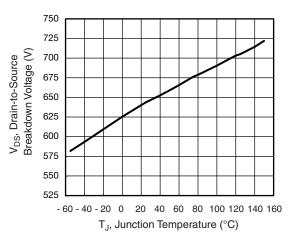
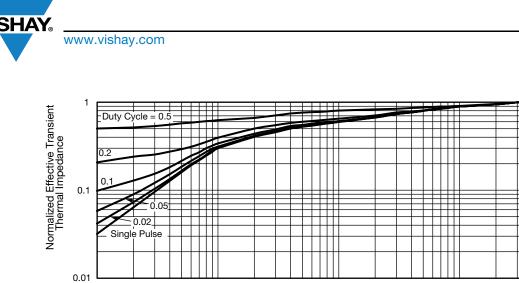


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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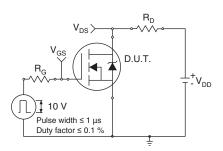


0.001



0.01

Pulse Time (s)



0.0001

Fig. 13 - Switching Time Test Circuit

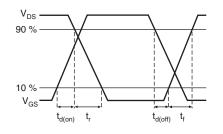


Fig. 14 - Switching Time Waveforms

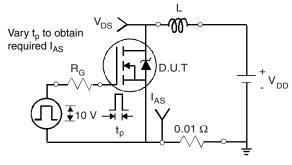


Fig. 15 - Unclamped Inductive Test Circuit

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0.1

Fig. 16 - Unclamped Inductive Waveforms

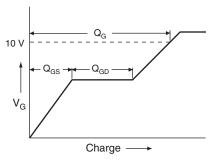
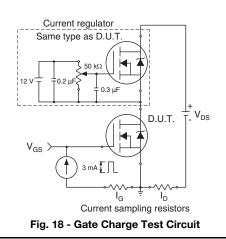


Fig. 17 - Basic Gate Charge Waveform



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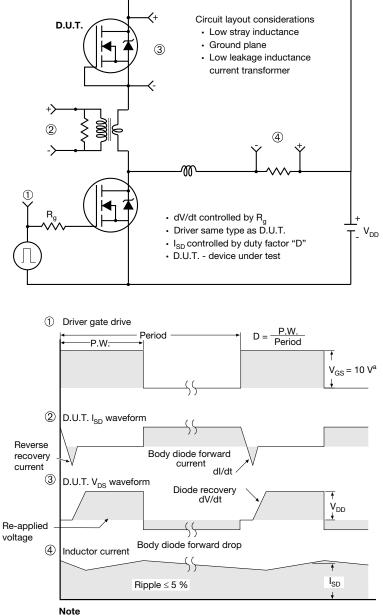
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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TO-220-1



DIM	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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